

Absolute Maximum Ratings(Note 1)
Storage Temperature
Ambient Temperature under Bias
Junction Temperature under Bias
$\mathrm{V}_{\mathrm{CC}}$ Pin Potential to Ground Pin
Input Voltage (Note 2)
Input Current (Note 2)
Voltage Applied to Any Output
in the Disabled or

$$
\text { Power-Off State } \quad-0.5 \mathrm{~V} \text { to } 5.5 \mathrm{~V}
$$

in the HIGH State
Current Applied to Output
in LOW State (Max)
DC Latchup Source Current
Over Voltage Latchup (I/O)

## Recommended Operating

 Conditions| Free Air Ambient Temperature | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| :--- | ---: |
| Supply Voltage | +4.5 V to +5.5 V |
| Minimum Input Edge Rate $(\Delta \mathrm{V} / \Delta \mathrm{t})$ |  |
| $\quad$ Data Input | $50 \mathrm{mV} / \mathrm{ns}$ |
| Enable Input | $20 \mathrm{mV} / \mathrm{ns}$ |

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.
Note 2: Either voltage limit or current limit is sufficient to protect inputs.

## DC Electrical Characteristics

| Symbol | Parameter | Min | Typ | Max | Units | $V_{\text {CC }}$ |
| :--- | :--- | :---: | :---: | :---: | :--- | :--- |

## DC Electrical Characteristics

(Solc Package)

| Symbol | Parameter | Min | Typ | Max | Units | $\mathrm{V}_{\mathrm{cc}}$ | Conditions $\mathrm{C}_{\mathrm{L}}=\mathbf{5 0} \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {OLP }}$ | Quiet Output Maximum Dynamic $\mathrm{V}_{\mathrm{OL}}$ |  | 0.6 | 0.8 | V | 5.0 | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 5) |
| $\mathrm{V}_{\text {OLV }}$ | Quiet Output Minimum Dynamic $\mathrm{V}_{\mathrm{OL}}$ | -0.5 | -0.4 |  | V | 5.0 | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 5) |
| $\mathrm{V}_{\text {OHV }}$ | Minimum HIGH Level Dynamic Output Voltage | 2.7 | 3.1 |  | V | 5.0 | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 6) |
| $\mathrm{V}_{\text {IHD }}$ | Minimum HIGH Level Dynamic Input Voltage | 2.0 | 1.4 |  | V | 5.0 | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 7) |
| $\mathrm{V}_{\text {ILD }}$ | Maximum LOW Level Dynamic Input Voltage |  | 1.2 | 0.8 | V | 5.0 | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 7) |

Note 5: Max number of outputs defined as (n). $\mathrm{n}-1$ data inputs are driven 0 V to 3 V . One output at LOW. Guaranteed, but not tested.
Note 6: Max number of data inputs ( n ) switching. $\mathrm{n}-1$ inputs switching 0 V to 3 V . Input-under-test switching: 3 V to threshold ( $\mathrm{V}_{\mathrm{ILD}}$ ), 0 V to threshold ( $\mathrm{V}_{\text {IHD }}$ ). Guaranteed, but not tested.
Note 7: Max number of outputs defined as ( n ). $\mathrm{n}-1$ data inputs are driven 0 V to 3 V . One output HIGH. Guaranteed, but not tested.

## AC Electrical Characteristics

| Symbol | Parameter | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CC}}=+5 \mathrm{~V} \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{aligned}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}-5.5 \mathrm{~V} \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{gathered}$ |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Max |  |
| $t_{\text {PLH }}$ | Propagation Delay Data to Outputs | 1.0 | 2.3 | 3.6 | 1.0 | 3.6 | ns |
| $\mathrm{t}_{\text {PHL }}$ |  | 1.0 | 3.3 | 4.1 | 1.0 | 4.1 |  |
| $\mathrm{t}_{\text {PZH }}$ | Output Enable Time | 1.5 | 3.7 | 6.0 | 1.5 | 6.0 | ns |
|  |  | 1.5 | 4.3 | 6.5 | 1.5 | 6.5 |  |
| $\mathrm{t}_{\text {PHZ }}$ | Output Disable Time | 1.0 | 3.5 | 6.0 | 1.0 | 6.0 | ns |
| $t_{\text {PLZ }}$ |  | 1.0 | 3.7 | 5.6 | 1.0 | 5.6 |  |

## Extended AC Electrical Characteristics

(SOIC Package)

| Symbol | Parameter | $\begin{gathered} -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}-5.5 \mathrm{~V} \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{gathered}$ <br> 8 Outputs Switching (Note 8) |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}-5.5 \mathrm{~V} \\ \mathrm{C}_{\mathrm{L}}=250 \mathrm{pF} \end{gathered}$ <br> 1 Output Switching (Note 9) |  | $\begin{gathered} \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}-5.5 \mathrm{~V} \\ \mathrm{C}_{\mathrm{L}}=250 \mathrm{pF} \end{gathered}$ <br> 8 Outputs Switching <br> (Note 10) |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Max | Min | Max |  |
| $\mathrm{f}_{\text {TOGGLE }}$ | Maximum Toggle Frequency |  | 100 |  |  |  |  |  | MHz |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | Propagation Delay Data to Outputs | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ |  | $\begin{aligned} & 5.0 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{gathered} 6.0 \\ 10.0 \end{gathered}$ | $\begin{aligned} & 2.5 \\ & 2.5 \end{aligned}$ | $\begin{gathered} 8.5 \\ 11.0 \end{gathered}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PZH}} \\ & \mathrm{t}_{\mathrm{PZL}} \end{aligned}$ | Output Enable Time | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ |  | $\begin{aligned} & 6.5 \\ & 7.0 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 2.5 \end{aligned}$ | $\begin{gathered} \hline 7.5 \\ 11.0 \end{gathered}$ | $\begin{aligned} & 2.5 \\ & 2.5 \end{aligned}$ | $\begin{gathered} 9.5 \\ 12.5 \end{gathered}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PHZ}} \\ & \mathrm{t}_{\mathrm{PLZ}} \end{aligned}$ | Output Disable Time | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ |  | $\begin{aligned} & \hline 6.0 \\ & 6.0 \end{aligned}$ | (Note 11) |  | (Note 11) |  | ns |

Note 8: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).

Note 9: This specification is guaranteed but not tested. The limits represent propagation delay with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only
Note 10: This specification is guaranteed but not tested. The limits represent propagation delays for all paths described switching in phase
(i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.) with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 11: The 3-STATE delays are dominated by the RC network ( $500 \Omega, 250 \mathrm{pF}$ ) on the output and have been excluded from the datasheet.

Skew

| (SOIC Packa |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Symbol | Parameter | $\begin{gathered} \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}-5.5 \mathrm{~V} \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{gathered}$ <br> 8 Outputs Switching (Note 12) | $\begin{gathered} \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}-5.5 \mathrm{~V} \\ \mathrm{C}_{\mathrm{L}}=250 \mathrm{pF} \end{gathered}$ <br> 8 Outputs Switching (Note 13) | Units |
|  |  | Max | Max |  |
| ${ }^{\mathrm{t}} \mathrm{OSHL}$ <br> (Note 14) | Pin to Pin Skew HL Transitions | 1.3 | 2.3 | ns |
| $\mathrm{t}_{\mathrm{OSLH}}$ <br> (Note 14) | Pin to Pin Skew <br> LH Transitions | 1.0 | 1.8 | ns |
| $t_{P S}$ <br> (Note 15) | Duty Cycle LH-HL Skew | 2.0 | 5.0 | ns |
| tost <br> (Note 14) | Pin to Pin Skew LH/HL Transitions | 2.0 | 5.0 | ns |
| $\mathrm{t}_{\mathrm{PV}}$ <br> (Note 16) | Device to Device Skew LH/HL Transitions | 2.0 | 5.0 | ns |

Note 12: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.)

Note 13: These specifications guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.
Note 14: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device The specification applies to any outputs switching HIGH-to-LOW (toshl), LOW-to-HIGH (tOSLH), or any combination switching LOW-to-HIGH and/or HIGH-to-LOW ( $t_{\mathrm{OST}}$ ). The specification is guaranteed but not tested.

Note 15: This describes the difference between the delay of the LOW-to-HIGH and the HIGH-to-LOW transition on the same pin. It is measured across all the outputs (drivers) on the same chip, the worst (largest delta) number is the guaranteed specification. This specification is guaranteed but not tested. Note 16: Propagation delay variation for a given set of conditions (i.e., temperature and $V_{C C}$ ) from device to device. This specification is guaranteed but not tested

## Capacitance

| Symbol | Parameter | Typ | Units | Conditions <br> $\mathbf{T}_{\mathbf{A}}=\mathbf{2 5}{ }^{\circ} \mathbf{C}$ |
| :--- | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{IN}}$ | Input Capacitance | 5.0 | pF | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ |
| $\mathrm{C}_{\mathrm{OUT}}$ (Note 17) | Output Capacitance | 9.0 | pF | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$ |

Note 17: $\mathrm{C}_{\text {OUT }}$ is measured at frequency $\mathrm{f}=1 \mathrm{MHz}$; per MIL-STD-883, Method 3012.

## AC Loading



FIGURE 1．Standard AC Test Load


FIGURE 2．Test Input Signal Levels

| Amplitude | Rep．Rate | $\mathbf{t}_{\mathbf{W}}$ | $\mathbf{t}_{\mathbf{r}}$ | $\mathbf{t}_{\mathbf{f}}$ |
| :---: | :---: | :---: | :---: | :---: |
| 3.0 V | 1 MHz | 500 ns | 2.5 ns | 2.5 ns |

FIGURE 3．Test Input Signal Requirements

## AC Waveforms



FIGURE 4．Propagation Delay Waveforms for Inverting and Non－Inverting Functions


FIGURE 5．Propagation Delay，Pulse Width Waveforms


FIGURE 6．3－STATE Output HIGH and LOW Enable and Disable Times


FIGURE 7．Setup Time，Hold Time and Recovery Time Waveforms


Physical Dimensions inches（millimeters）unless otherwise noted（Continued）



20－Lead Small Outline Package（SOP），EIAJ TYPE II，5．3mm Wide Package Number M20D


Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



LAND PATTERN RECOMMENDATION



DETAILA

NOTES:
A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUUIONS.
D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982

MTC20RevD1

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20

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